

PRODUCT INFORMATION LETTER

PIL MMS-MIC/14/8569 Dated 10 Jul 2014

STM32F42x and STM32F43x family Errata sheet update

Sales Type/product family label	STM32F42x and STM32F43x products lisetd below
Type of change	Product electrical spec. change
Reason for change	Product limitation described in Errata sheet update
Description	STM32F42x and STM32F43x Errata sheet is updated to include a product limitation.
Forecasted date of implementation	10-Aug-2014
Forecasted date of samples for customer	03-Jul-2014
Forecasted date for STMicroelectronics change Qualification Plan results availability	03-Jul-2014
Involved ST facilities	not applicable

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DOCUMENT APPROVAL



PRODUCT INFORMATION LETTER

STM32F42x and STM32F43x family Errata sheet update

MMS - Microcontrollers Division (MCD)

Dear Customer,

We wish to inform you that the STM32F42x and STM32F43x Errata sheet is updated to include a product limitation.

What is the change?

When PA12 is used as GPIO or alternate function in input or output mode, the data read from Flash memory can be corrupted. This behavior is only observed when the following conditions are met:

- The device operates from a 2.7 to 3.6 V VDD power supply whatever the temperature range.
- Flash memory Bank2 is used or dual bank feature enabled.

Impacted products (listed below):

- STM32F42xxI & STM32F43xxI part numbers.
- STM32F42xxG & STM32F43xxG part numbers only when dual bank feature is enabled

Not impacted products:

- STM32F42xxG & STM32F43xxG part numbers when dual bank feature is disabled
- STM32F42xxE & STM32F43xxE part numbers

Workaround

PA12 must be left unconnected on the PCB (configured as push-pull and held Low). You can use all the other GPIOs and all alternate functions except for the ones mapped on PA12. Use the OTG_HS peripheral in full-speed mode instead of the OTG_FS peripheral.

This limitation is fixed in silicon revision 3.

We remain available to discuss any concern you may have regarding this product information.

With our sincere regards. Michel Buffa Microcontroller Division General Manager

List of commercial products impacted:

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